

# 1011LD200

# 200 Watts, 32 Volts Pulsed Avionics 1030 to 1090 MHz LDMOS FET

#### **GENERAL DESCRIPTION**

The 1011LD200 is a COMMON SOURCE N-Channel enhancement mode lateral MOSFET capable of providing 200  $W_{pk}$  of RF power from 1030 to 1090 MHz. The device is nitride passivated and utilizes gold metallization to ensure highest MTTF. The transistor includes input prematch for broadband capability. Low thermal resistance package reduces junction temperature, extends life.

### CASE OUTLINE 55QX-1 (Common Source)

#### ABSOLUTE MAXIMUM RATINGS

**Power Dissipation** 

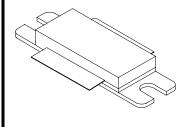
Device Dissipation @25°C (P<sub>d</sub>) 700 W

**Voltage and Current** 

Drain-Source ( $V_{DSS}$ ) 75V Gate-Source ( $V_{GS}$ )  $\pm 20V$ 

**Temperatures** 

Storage Temperature -65 to +150°C Operating Junction Temperature +200°C



#### **ELECTRICAL CHARACTERISTICS @ 25°C**

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN	TYP	MAX	UNITS
$BV_{dss}$	Drain-Source Breakdown	$V_{gs} = 0V, I_d = 20mA$	75			V
$I_{dss}$	Drain-Source Leakage Current	$V_{ds} = 38V, V_{gs} = 0V$			10	μΑ
$I_{gss}$	Gate-Source Leakage Current	$V_{gs} = 10V, V_{ds} = 0V$			1	μΑ
$V_{gs(th)}$	Gate Threshold Voltage	$V_{ds} = 10V, I_d = 40 \text{ mA}$	3		6	V
V <sub>ds(on)</sub>	Drain-Source On Voltage	$V_{gs} = 10V$ , $I_d = 2A$			0.3	V
$g_{FS}$	Forward Transconductance	$V_{ds} = 10V, I_{d} = 2A$		2		S
$\theta_{ m JC}^{-1}$	Thermal Resistance				0.25	°C/W

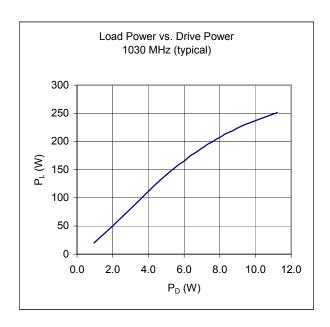
#### FUNCTIONAL CHARACTERISTICS @ 25°C, Vds = 32V, I<sub>dq</sub> = 500mA

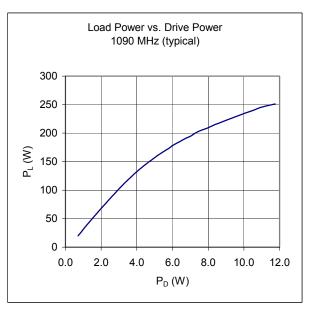
$G_{PS}$	Common Source Power Gain	Pulse width = 32 μs, LTDC=2%	13	15		dB
Pd	Pulse Droop	$F=1030/1090 \text{ MHz}, P_{\text{out}} = 200 \text{W}$			0.5	dB
$\eta_d$	Drain Efficiency	$F = 1030 \text{ MHz}, P_{out} = 200 \text{W}$	43			%
Ψ	Load Mismatch	$F = 1090 \text{ MHz}, P_{out} = 200 \text{W}$			3:1	

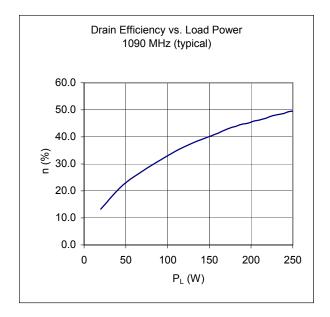
NOTES: 1. At rated output power and pulse conditions

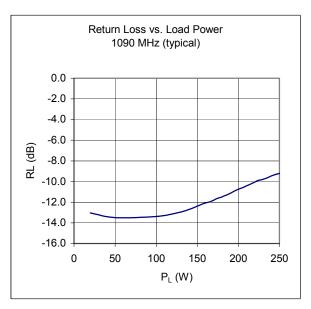
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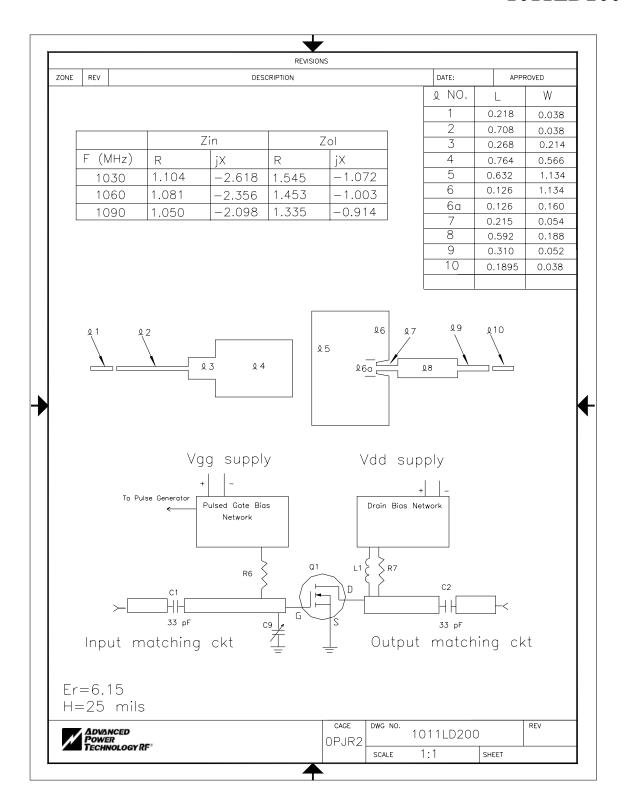












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